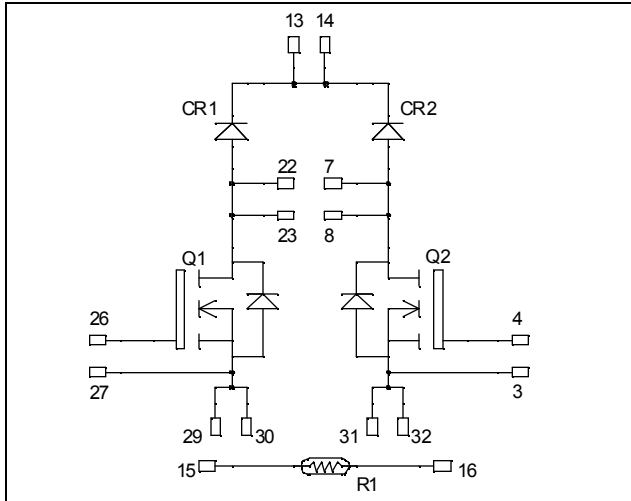


## Dual Boost chopper MOSFET Power Module

$$V_{DSS} = 500V$$

$$R_{DSon} = 65m\Omega \text{ typ @ } T_j = 25^\circ C$$

$$I_D = 51A \text{ @ } T_c = 25^\circ C$$

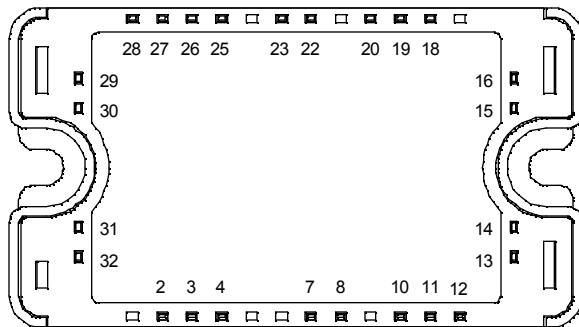


### Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

### Features

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration



### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a single boost of twice the current capability
- RoHS Compliant

All multiple inputs and outputs must be shorted together  
 Example: 13/14 ; 29/30 ; 22/23 ...

### Absolute maximum ratings

| Symbol     | Parameter                                         | Max ratings        | Unit      |
|------------|---------------------------------------------------|--------------------|-----------|
| $V_{DSS}$  | Drain - Source Breakdown Voltage                  | 500                | V         |
| $I_D$      | Continuous Drain Current                          | $T_c = 25^\circ C$ | A         |
|            |                                                   | $T_c = 80^\circ C$ |           |
| $I_{DM}$   | Pulsed Drain current                              | 204                |           |
| $V_{GS}$   | Gate - Source Voltage                             | $\pm 30$           | V         |
| $R_{DSon}$ | Drain - Source ON Resistance                      | 78                 | $m\Omega$ |
| $P_D$      | Maximum Power Dissipation                         | $T_c = 25^\circ C$ | 390       |
| $I_{AR}$   | Avalanche current (repetitive and non repetitive) | 51                 | A         |
| $E_{AR}$   | Repetitive Avalanche Energy                       | 50                 | mJ        |
| $E_{AS}$   | Single Pulse Avalanche Energy                     | 3000               |           |

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

**All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified**

**Electrical Characteristics**

| Symbol       | Characteristic                  | Test Conditions                                       | Min | Typ | Max       | Unit             |
|--------------|---------------------------------|-------------------------------------------------------|-----|-----|-----------|------------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 500V, T_j = 25^\circ\text{C}$  |     |     | 100       | $\mu\text{A}$    |
|              |                                 | $V_{GS} = 0V, V_{DS} = 400V, T_j = 125^\circ\text{C}$ |     |     | 500       |                  |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10V, I_D = 25.5A$                           |     | 65  | 78        | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 2.5\text{mA}$                 | 3   |     | 5         | V                |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 30V, V_{DS} = 0V$                       |     |     | $\pm 100$ | nA               |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions                                                                                                                     | Min | Typ  | Max | Unit          |
|--------------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0V$<br>$V_{DS} = 25V$<br>$f = 1\text{MHz}$                                                                                |     | 7000 |     | pF            |
| $C_{oss}$    | Output Capacitance           |                                                                                                                                     |     | 1400 |     |               |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                                                                                                     |     | 90   |     |               |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10V$<br>$V_{Bus} = 250V$<br>$I_D = 51A$                                                                                   |     | 140  |     | nC            |
| $Q_{gs}$     | Gate – Source Charge         |                                                                                                                                     |     | 40   |     |               |
| $Q_{gd}$     | Gate – Drain Charge          |                                                                                                                                     |     | 70   |     |               |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15V$<br>$V_{Bus} = 333V$<br>$I_D = 51A$<br>$R_G = 3\Omega$ |     | 21   |     | ns            |
| $T_r$        | Rise Time                    |                                                                                                                                     |     | 38   |     |               |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                                     |     | 75   |     |               |
| $T_f$        | Fall Time                    |                                                                                                                                     |     | 93   |     |               |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>25^\circ\text{C}</math></b><br>$V_{GS} = 15V, V_{Bus} = 333V$<br>$I_D = 51A, R_G = 3\Omega$          |     | 1035 |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                     |     | 845  |     |               |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15V, V_{Bus} = 333V$<br>$I_D = 51A, R_G = 3\Omega$         |     | 1556 |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                     |     | 1013 |     |               |

**Diode ratings and characteristics**

| Symbol           | Characteristic                          | Test Conditions                                                 |                        | Min | Typ  | Max | Unit |
|------------------|-----------------------------------------|-----------------------------------------------------------------|------------------------|-----|------|-----|------|
| V <sub>RRM</sub> | Maximum Peak Repetitive Reverse Voltage |                                                                 |                        | 600 |      |     | V    |
| I <sub>RM</sub>  | Maximum Reverse Leakage Current         | V <sub>R</sub> =600V                                            | T <sub>j</sub> = 25°C  |     |      | 350 | μA   |
|                  |                                         |                                                                 | T <sub>j</sub> = 125°C |     |      | 600 |      |
| I <sub>F</sub>   | DC Forward Current                      |                                                                 | T <sub>c</sub> = 70°C  |     | 80   |     | A    |
| V <sub>F</sub>   | Diode Forward Voltage                   | I <sub>F</sub> = 80A                                            | T <sub>j</sub> = 25°C  |     | 1.45 |     | V    |
|                  |                                         |                                                                 | T <sub>j</sub> = 125°C |     | 1.35 |     |      |
| t <sub>rr</sub>  | Reverse Recovery Time                   | I <sub>F</sub> = 80A<br>V <sub>R</sub> = 300V<br>di/dt=4500A/μs | T <sub>j</sub> = 25°C  |     | 95   |     | ns   |
|                  |                                         |                                                                 | T <sub>j</sub> = 125°C |     | 115  |     |      |
| Q <sub>rr</sub>  | Reverse Recovery Charge                 |                                                                 | T <sub>j</sub> = 25°C  |     | 5.2  |     | μC   |
|                  |                                         |                                                                 | T <sub>j</sub> = 125°C |     | 8    |     |      |

## Thermal and package characteristics

| Symbol            | Characteristic                                                            |             |    | Min        | Typ | Max  | Unit |
|-------------------|---------------------------------------------------------------------------|-------------|----|------------|-----|------|------|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance                                       |             |    | Transistor |     | 0.32 | °C/W |
|                   |                                                                           |             |    | Diode      |     | 0.8  |      |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz |             |    | 2500       |     |      | V    |
| T <sub>J</sub>    | Operating junction temperature range                                      |             |    | -40        |     | 150  | °C   |
| T <sub>STG</sub>  | Storage Temperature Range                                                 |             |    | -40        |     | 125  |      |
| T <sub>C</sub>    | Operating Case Temperature                                                |             |    | -40        |     | 100  |      |
| Torque            | Mounting torque                                                           | To heatsink | M4 | 2.5        |     | 4.7  | N.m  |
| Wt                | Package Weight                                                            |             |    |            |     | 110  | g    |

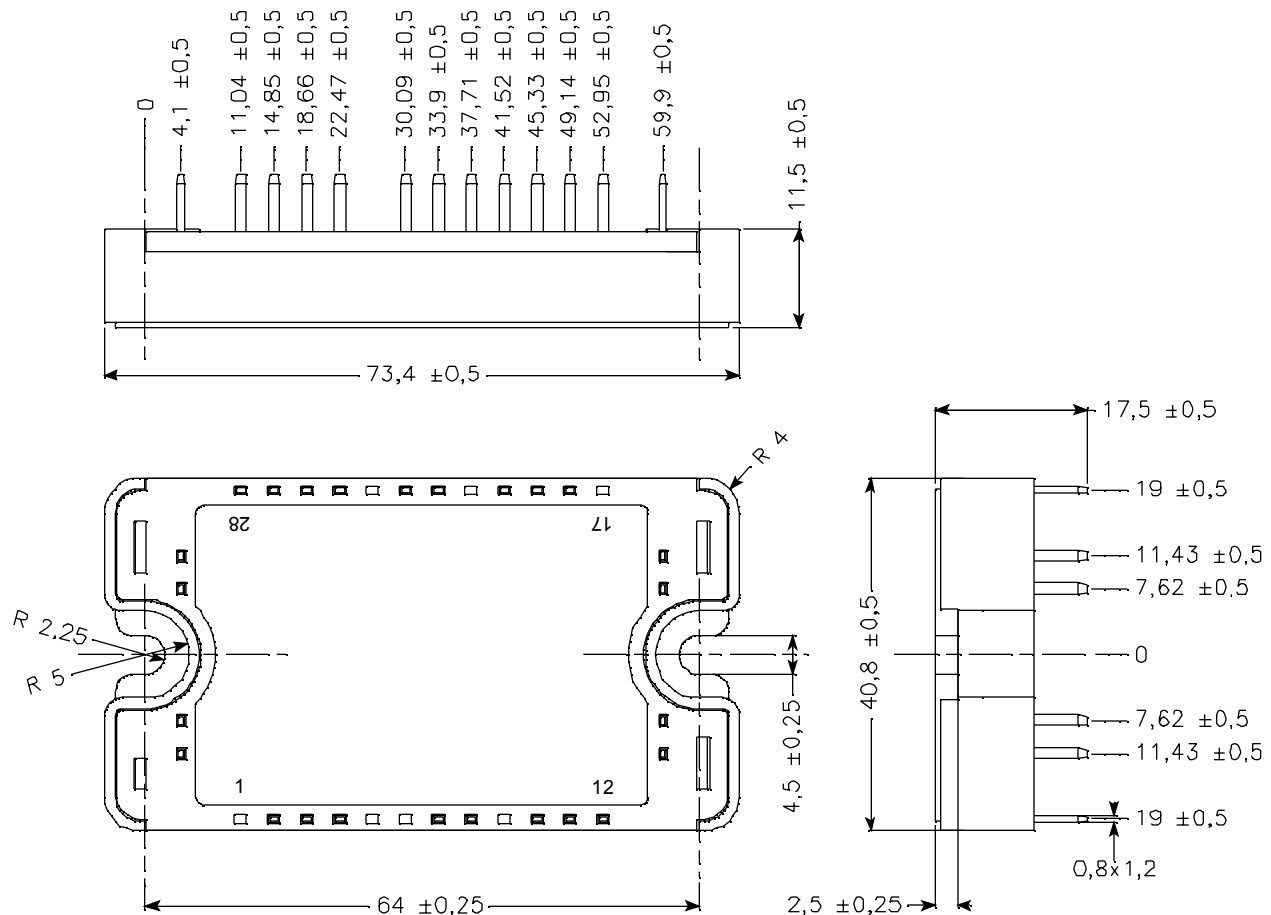
## Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

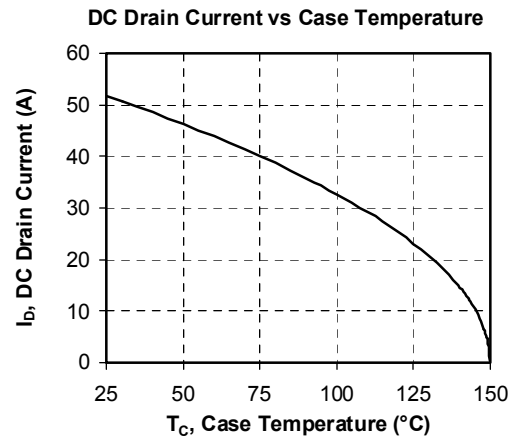
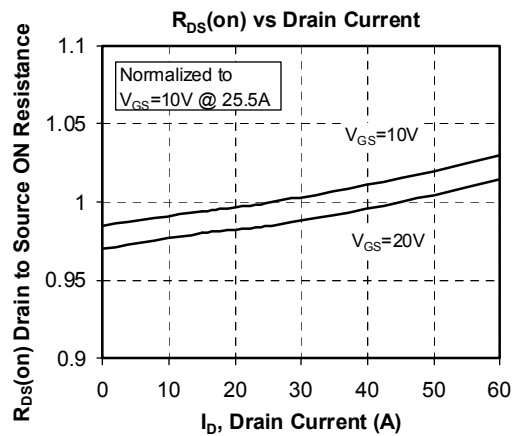
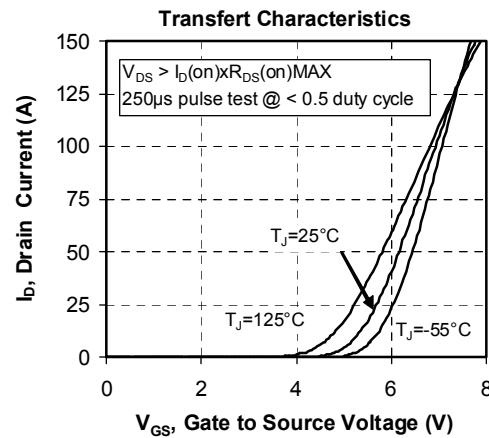
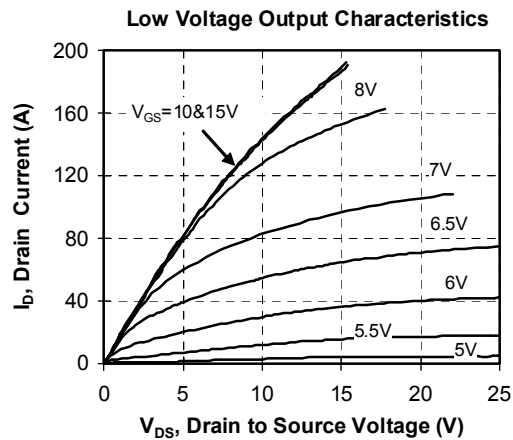
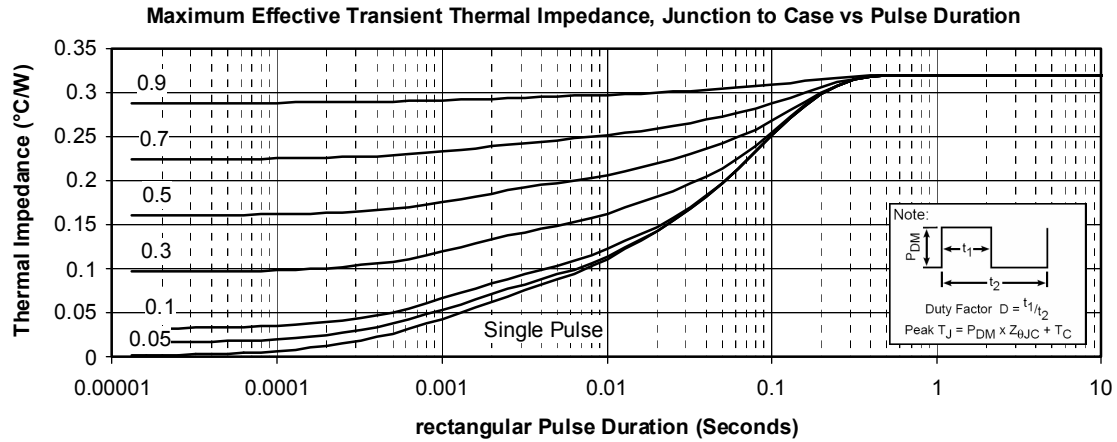
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

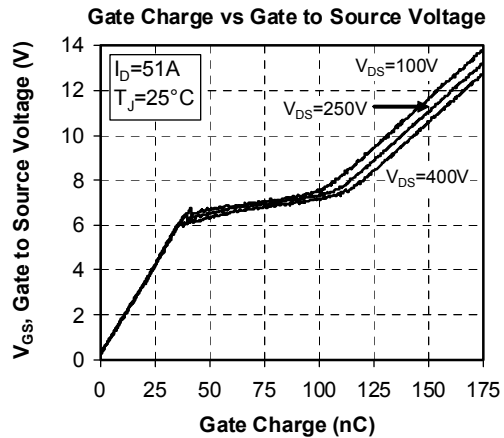
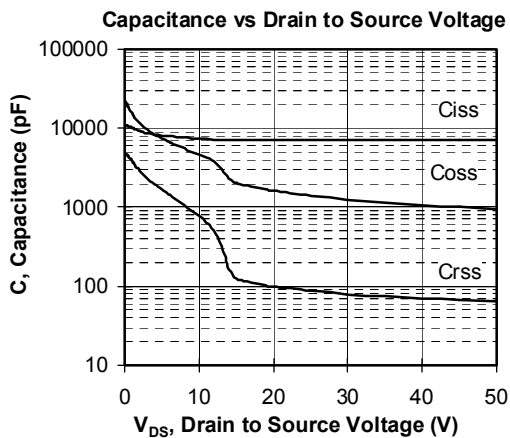
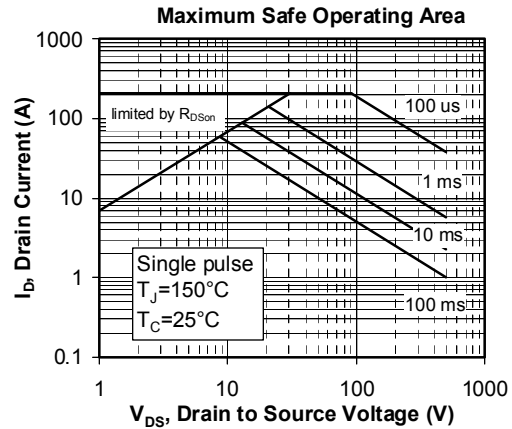
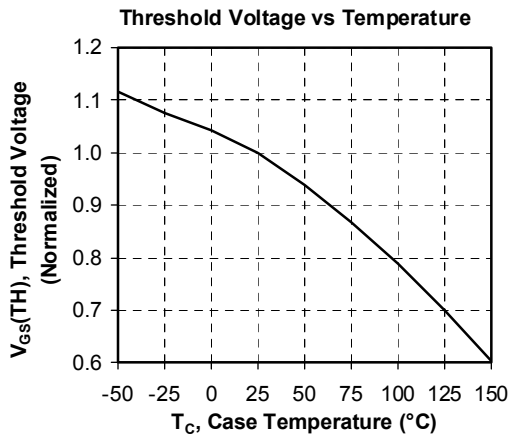
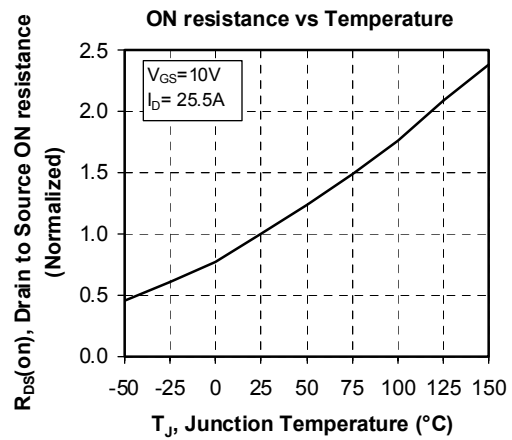
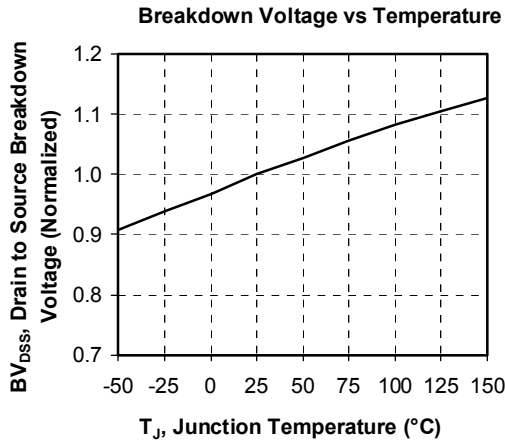
## SP3 Package outline (dimensions in mm)

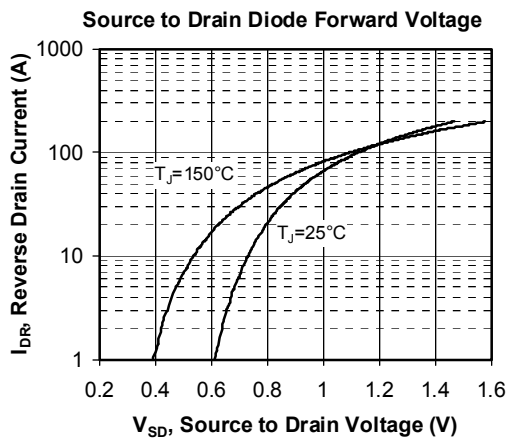
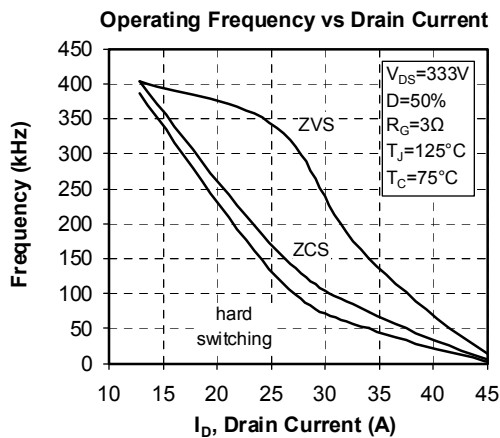
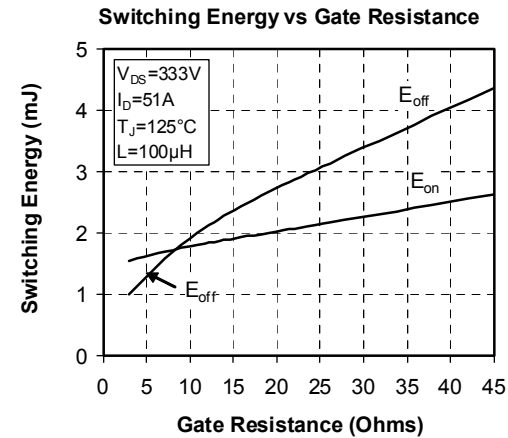
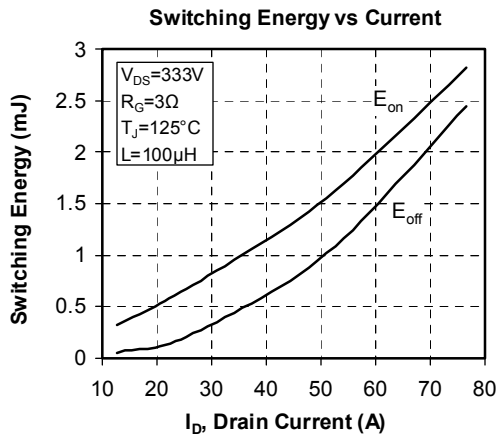
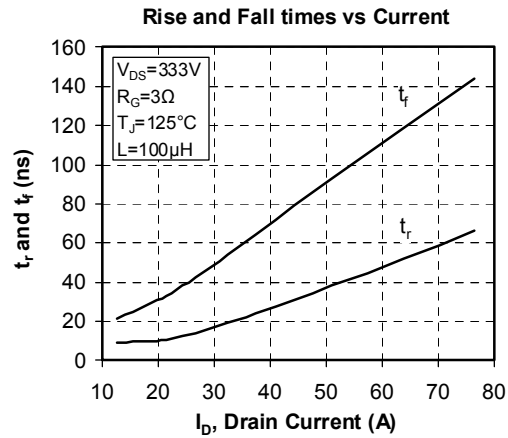
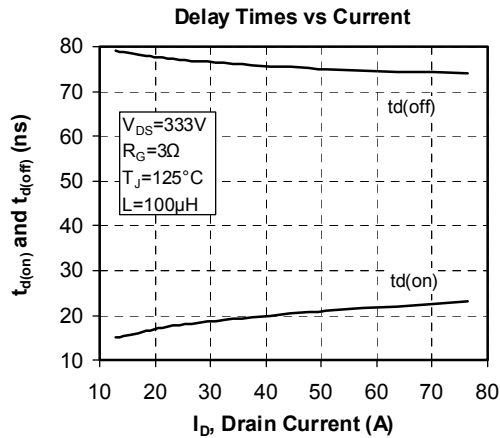


See application note 1901 - Mounting Instructions for SP3 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve







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